



CORRIGENDUM

Spatial imaging with 3D capacitance measurements

To cite this article: R Wajman *et al* 2007 *Meas. Sci. Technol.* **18** 3671

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Corrigendum

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R Wajman, R Banasiak, L Mazurkiewicz, T Dyakowski
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2113–2118

The authors unintentionally omitted to mention that parallel work on 3D ECT has been developed by Warsito and Fan (2003) but using the artificial neural networks to 3D image reconstruction (where our group concentrated on algebraic methods) and that the rectangular shape of electrodes was also used by Warsito and Fan (2003) but in a twin-plane sensor (where our group used three or more planes).

Reference

Warsito W and Fan L S 2003 Development of three-dimensional electrical capacitance tomography *Proc. 3rd World Congress on Industrial Process Tomography (Banff, Canada, 2–5 September 2003)* pp 391–6